



RAYSTAR

RAYSTAR Optronics, Inc.  
曜凌光電股份有限公司



# 曜凌光電股份有限公司 Raystar Optronics, Inc.

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## RFA6400E-AWW-MNN

### SPECIFICATION

CUSTOMER:

|                    |  |
|--------------------|--|
| <b>APPROVED BY</b> |  |
| <b>PCB VERSION</b> |  |
| <b>DATE</b>        |  |

FOR CUSTOMER USE ONLY

| <b>SALES BY</b> | <b>APPROVED BY</b> | <b>CHECKED BY</b> | <b>PREPARED BY</b> |
|-----------------|--------------------|-------------------|--------------------|
|                 |                    |                   |                    |

Release DATE:

TFT Display Inspection Specification: <https://www.raystar-optronics.com/download/products.htm>  
Precaution in use of TFT module: <https://www.raystar-optronics.com/download/declaration.htm>

## Revision History

| VERSION | DATE       | REVISED PAGE NO. | Note                       |
|---------|------------|------------------|----------------------------|
| 0       | 2020/06/22 |                  | First issue                |
| A       | 2020/07/02 |                  | Remove the pull tape       |
| B       | 2020/08/06 |                  | Add Current                |
| C       | 2020/12/03 |                  | Modify Interface<br>Timing |
| D       | 2021/05/10 |                  | Modify Contour<br>drawing  |

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## 2.Summary

TFT 4.0" is a color active matrix thin film transistor (TFT) liquid crystal display (LCD) that uses amorphous silicon TFT as a switching device. This TFT LCD has a 4.0 (1:1) inch diagonally measured active display area with 480x480 (480 horizontal by 480 vertical pixel) resolution.

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### 3. General Specifications

- Size: 4.0 inch
- Dot Matrix: 480× 3(RGB) × 480 dots
- Module dimension: 78.8(H) \* 82.95 (W) \*4.77 mm
- Active area: 71.856(H)\*70.176 (V) mm
- Dot pitch: 0.1497(H)\*0.1462(V) mm
- LCD type: TFT, Normally Black, Transmissive
- View Direction: 80/80/80/80
- Aspect Ratio: 1:1
- Interface: 2-Lanes MIPI
- Driver IC: ST7701S
- Backlight Type: LED ,Normally White
- With /Without TP: Without TP
- Surface: Glare

\*Color tone slight changed by temperature and driving voltage.

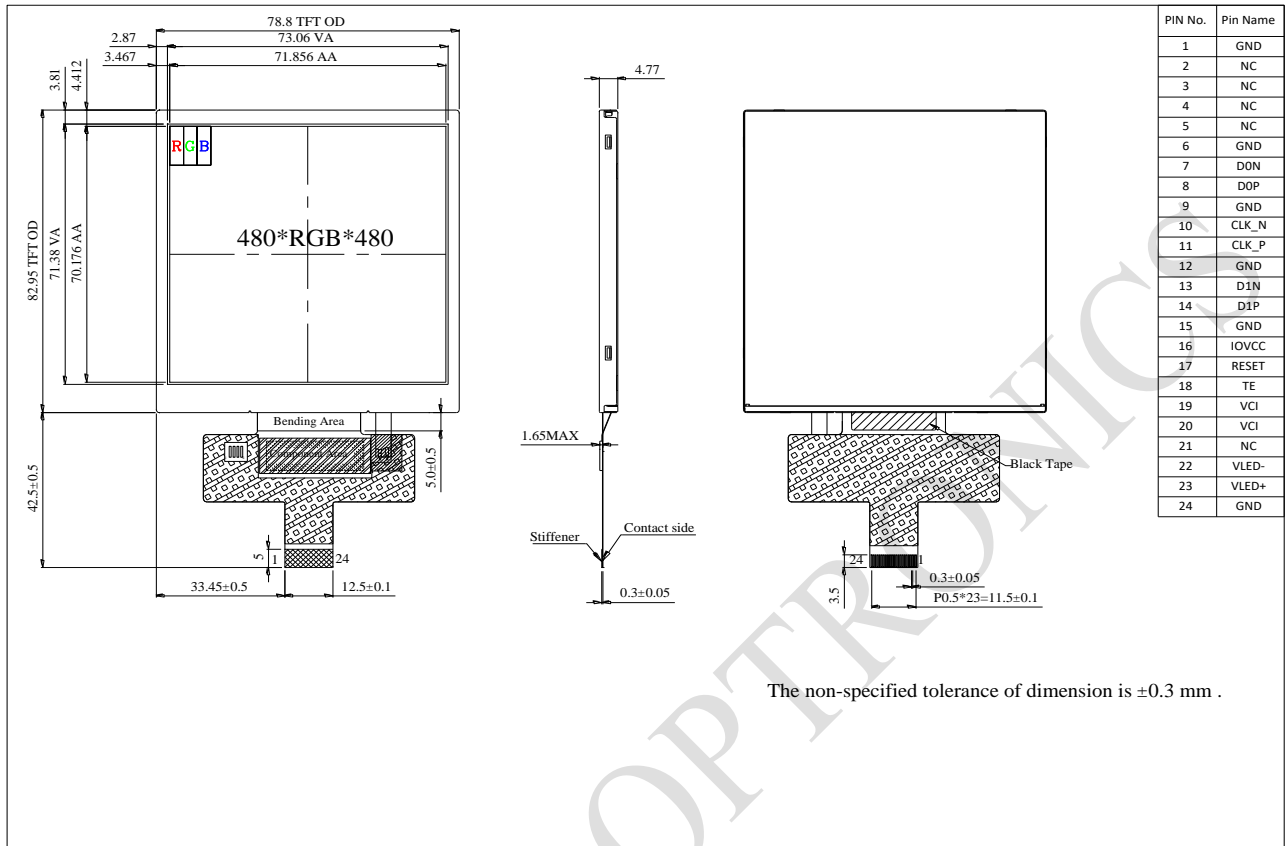


## 4.Interface

### 4.1. LCM PIN Definition

| Pin | Symbol | Function                                      |
|-----|--------|---|
| 1   | GND    | Power ground                                  |
| 2-5 | NC     | No connect                                    |
| 6   | GND    | Power ground                                  |
| 7   | D0N    | MIPI DSI differential data pair (Data lane 0) |
| 8   | D0P    |   |
| 9   | GND    | Power ground                                  |
| 10  | CLK_N  | MIPI DSI differential clock pair              |
| 11  | CLK_P  |   |
| 12  | GND    | Power ground                                  |
| 13  | D1N    | MIPI DSI differential data pair(Data lane 1)  |
| 14  | D1P    |   |
| 15  | GND    | Power ground                                  |
| 16  | IOVCC  | I/O and interface power supply (1.8V)         |
| 17  | RESET  | Reset input                                   |
| 18  | TE     | Tearing effect output pin.                    |
| 19  | VCI    | Analog power supply                           |
| 20  | VCI    | Analog power supply                           |
| 21  | NC     | No connect                                    |
| 22  | VLED-  | Power for LED backlight cathode               |
| 23  | VLED+  | Power for LED backlight anode                 |
| 24  | GND    | Power ground                                  |

# 5. Contour Drawing



## 6. Absolute Maximum Ratings

| Item                  | Symbol | Min | Typ | Max | Unit |
|-----------------------|--------|-----|-----|-----|------|
| Operating Temperature | TOP    | -30 | —   | +80 | □    |
| Storage Temperature   | TST    | -30 | —   | +80 | □    |

Note: Device is subject to be damaged permanently if stresses beyond those absolute maximum ratings listed above

- Temp. □60□, 90% RH MAX. Temp. > 60□, Absolute humidity shall be less than 90% RH at 60□

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## 7. Electrical Characteristics

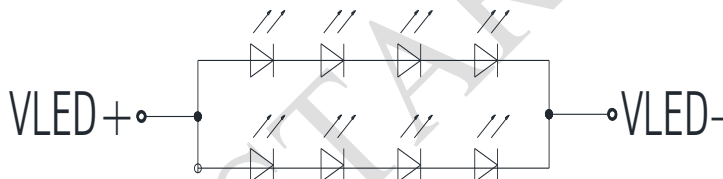
### 7.1. Typical Operation Conditions

| Item                      | Symbol             | Values |      |      | Unit | Remark |
|---------------------------|--------------------|--------|------|------|------|--------|
|                           |                    | Min.   | Typ. | Max. |      |        |
| Interface Supply Voltage  | VCI                | 2.5    | 2.8  | 3.6  | V    |        |
| Power voltage             | IOVCC              | 1.65   | 1.8  | 3.3  | V    |        |
| Current for Driver(White) | I <sub>vci</sub>   | -      | 39   | 58   | mA   |        |
|                           | I <sub>ioVCC</sub> | -      | 11   | 16.5 | mA   |        |

### 7.2. Backlight Driving Conditions

| Parameter     | Symbol            | Min.   | Typ. | Max. | Unit | Remark     |
|---------------|-------------------|--------|------|------|------|------------|
| LED current   | I <sub>LED</sub>  | -      | 100  | -    | mA   |            |
| LED voltage   | V <sub>LED+</sub> | 10.8   | 12.4 | 13.6 | V    | Note 1     |
| LED Life Time |                   | 50,000 | -    | -    | Hr   | Note 2,3,4 |

Note 1 : There are 1 Groups LED



CIRCUIT DIAGRAM

Note 2 :  $T_a = 25\text{ }^\circ\text{C}$

Note 3 : Brightness to be decreased to 50% of the initial value

Note 4 : The single LED lamp case.

# 8. Interface Timing

## 8.1. MIPI Interface Characteristics High Speed Mode

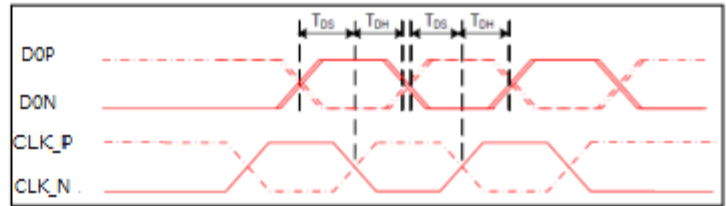
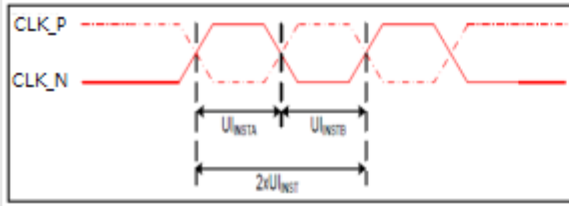


Figure 1 DSI clock channel timing

Figure 2 Rising and falling time on clock and data channel

$VDDI=1.8, VDD=2.8, AGND=DGND=0V, T_a=25^{\circ}C$

| Signal  | Symbol                       | Parameter                | MIN  | MAX  | Unit | Description                    |
|---------|------------------------------|--------------------------|------|------|------|--------------------------------|
| CLK_P/N | $2xUI_{INSTA}$               | Double UI instantaneous  | 4    | 25   | ns   |                                |
| CLK_P/N | $UI_{INSTA}$<br>$UI_{INSTB}$ | UI instantaneous halves  | 2    | 12.5 | ns   | $UI = UI_{INSTA} = UI_{INSTB}$ |
| D1P/N   | $t_{DS}$                     | Data to clock setup time | 0.15 | -    | UI   |                                |
| D1P/N   | $t_{DH}$                     | Data to clock hold time  | 0.15 | -    | UI   |                                |

Table 1 Mipi Interface-High Speed Mode Timing Characteristics

## Low Power Mode

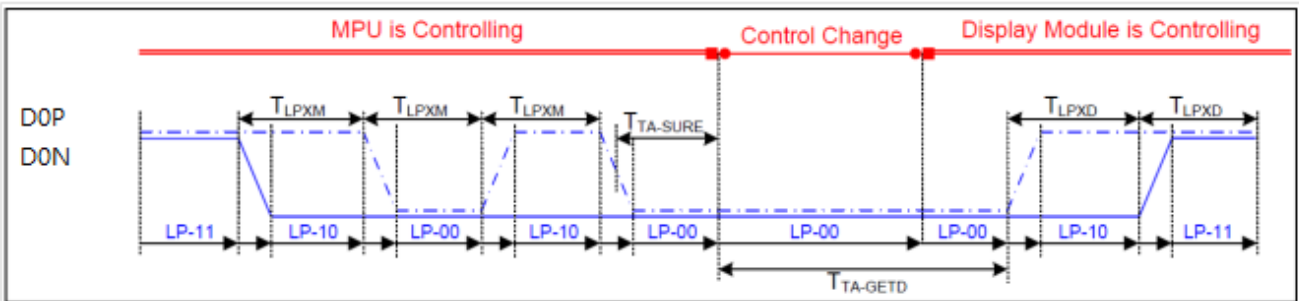


Figure 3 Bus Turnaround (BTA) from display module to MPU Timing

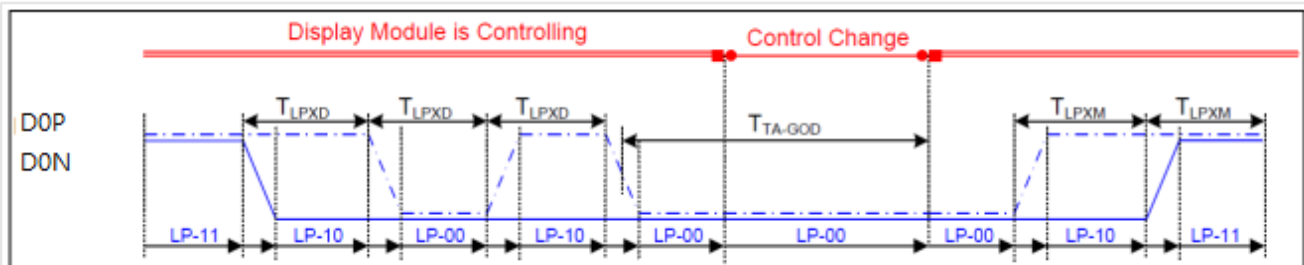


Figure 4 Bus Turnaround (BTA) from MPU to display module Timing

VDDI=1.8, VDD=2.8, AGND=DGND=0V, Ta=25°C

| Signal | Symbol    | Parameter  | MIN                 | MAX                 | Unit | Description |
|--------|-----------|--|---------------------|---------------------|------|-------------|
| D0P/N  | TLPXM     | Length of LP-00,LP-01, LP-10 or LP-11 periods MPU→Display Module | 50                  | 75                  | ns   | Input       |
| D0P/N  | TLPXD     | Length of LP-00,LP-01, LP-10 or LP-11 periods MPU→Display Module | 50                  | 75                  | ns   | Output      |
| D0P/N  | TTA-SURED | Time-out before the MPU start driving                            | $T_{LPXD}$          | $2 \times T_{LPXD}$ | ns   | Output      |
| D0P/N  | TTA-GETD  | Time to drive LP-00 by display module                            | $5 \times T_{LPXD}$ |                     | ns   | Input       |
| D0P/N  | TTA-GOD   | Time to drive LP-00 after turnaround request-MPU                 | $4 \times T_{LPXD}$ |                     | ns   | Output      |

Table 2 Mipi Interface Low Power Mode Timing Characteristics

DSI Bursts Mode

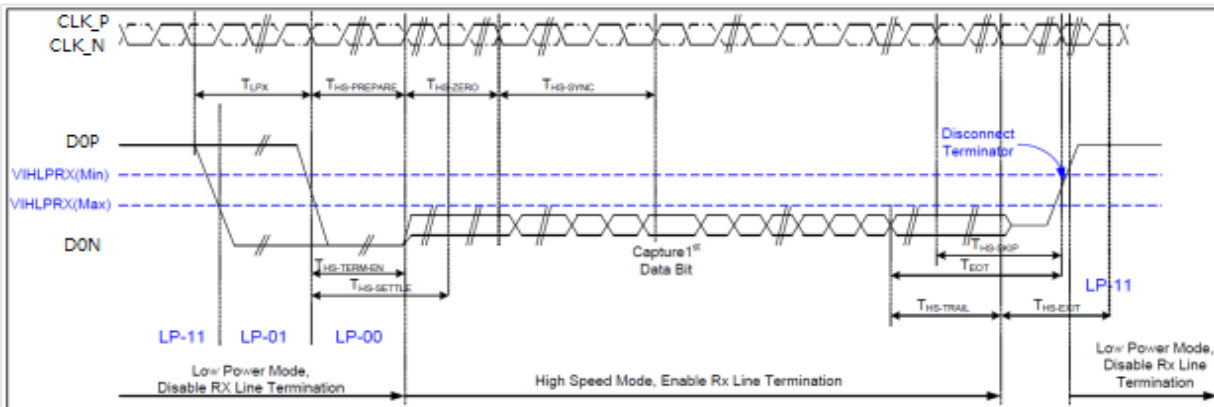


Figure 5 Data lanes-Low Power Mode to/from High Speed Mode Timing

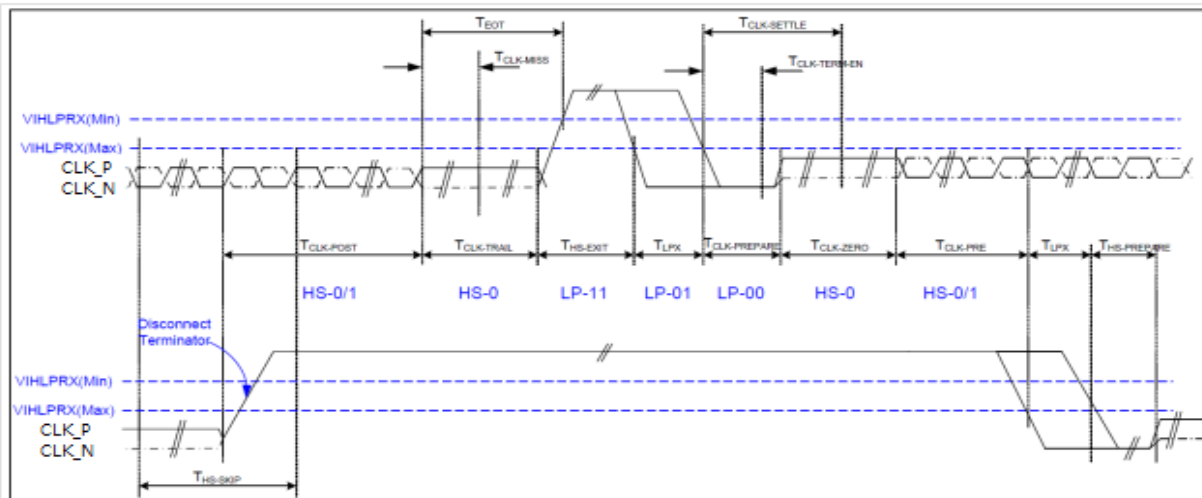


Figure 6 Clock lanes- High Speed Mode to/from Low Power Mode Timing

*VDDI=1.8, VDD=2.8, AGND=DGND=0V, Ta=25°C*

| Signal  | Symbol                   | Parameter  | MIN          | MAX                | Unit | Description |
|---|--------------------------|--|--------------|--------------------|------|-------------|
| Low Power Mode to High Speed Mode Timing      |                          |  |              |                    |      |             |
| D1P/N   | TLPX                     | Length of any low power state period   | 50           | -                  | ns   | Input       |
| D1P/N   | THS-PREPARE              | Time to drive LP-00 to prepare for HS transmission   | 40+4<br>UI   | 85+6<br>UI         | ns   | Input       |
| D1P/N   | THS-TERM-EN              | Time to enable data receiver line termination measured from when Dn crosses VILMAX                                   | -            | 35+4<br>UI         | ns   | Input       |
| D1P/N   | THS-PREPARE + THS-ZERO   | THS-PREPARE + time to drive HS-0 before the sync sequence  | 140+<br>10UI | -                  | ns   | Input       |
| High Speed Mode to Low Power Mode Timing      |                          |  |              |                    |      |             |
| D1P/N   | THS-SKIP                 | Time-out at display module to ignore transition period of EoT  | 40           | 55+4<br>UI         | ns   | Input       |
| D1P/N   | THS-EXIT                 | Time to drive LP-11 after HS burst   | 100          | -                  | ns   | Input       |
| D1P/N   | THS-TRAIL                | Time to drive flipped differential state after last payload data bit of a HS transmission burst                      | 60+4<br>UI   | -                  | ns   | Input       |
| High Speed Mode to/from Low Power Mode Timing |                          |  |              |                    |      |             |
| CLK_P/N                                       | TCLK-POS                 | Time that the MPU shall continue sending HS clock after the last associated data lane has transition to LP mode      | 60+5<br>2UI  | -                  | ns   | Input       |
| CLK_P/N                                       | TCLK-TRAIL               | Time to drive HS differential state after last payload clock bit of a HS transmission burst                          | 60           | -                  | ns   | Input       |
| CLK_P/N                                       | THS-EXIT                 | Time to drive LP-11 after HS burst   | 100          | -                  | ns   | Input       |
| CLK_P/N                                       | TCLK-PREPARE             | Time to drive LP-00 to prepare for HS transmission   | 38           | 95                 | ns   | Input       |
| CLK_P/N                                       | TCLK-TERM-EN             | Time-out at clock lan display module to enable HS transmission   | -            | 38                 | ns   | Input       |
| CLK_P/N                                       | TCLK-PREPARE + TCLK-ZERO | Minimum lead HS-0 drive period before starting clock   | 300          | -                  | ns   | Input       |
| CLK_P/N                                       | TCLK-PRE                 | Time that the HS clock shall be driven prior to any associated data lane beginning the transition from LP to HS mode | 8UI          | -                  | ns   | Input       |
| CLK_P/N                                       | TEOT                     | Time form start of TCLK-TRAIL period to start of LP-11 state   | -            | 105n<br>s+12<br>UI | ns   | Input       |

## 8.2. Reset Timing

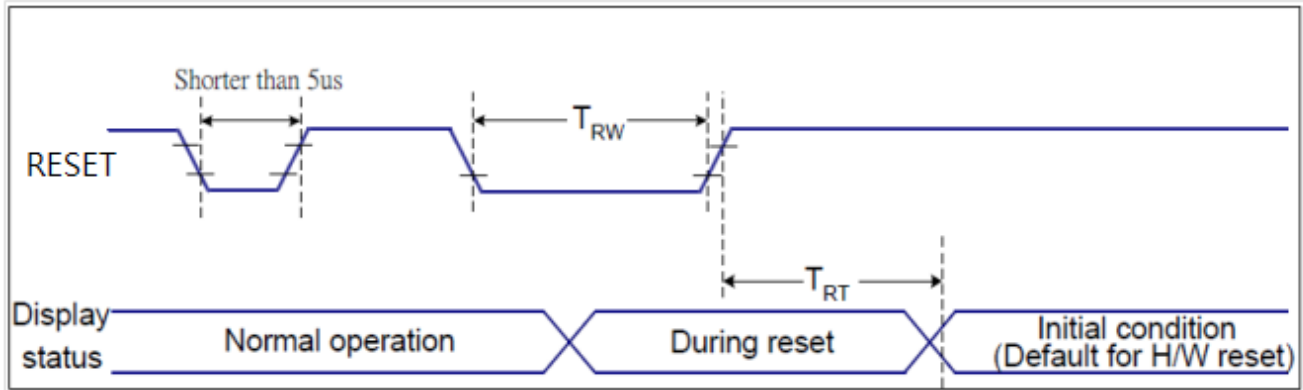


Figure 6 Reset Timing

VDDI=1.8, VDD=2.8, AGND=DGND=0V, Ta=25 °C

| Related Pins | Symbol | Parameter            | MIN | MAX                                 | Unit     |
|--------------|--------|----------------------|-----|-------------------------------------|----------|
| RESET        | TRW    | Reset pulse duration | 10  | -                                   | us       |
|              | TRT    | Reset cancel         | -   | 5 (Note 1, 5)<br>120 (Note 1, 6, 7) | ms<br>ms |

Table 3 Reset Timing

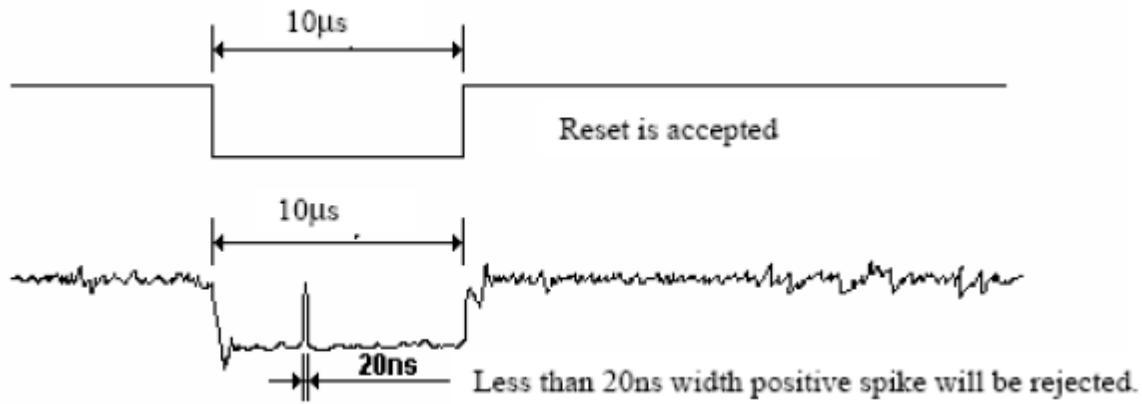
Notes:

- The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NVM (or similar device) to registers. This loading is done every time when there is HW reset cancel time (tRT) within 5 ms after a rising edge of RESX.
- Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below:

| RESET Pulse         | Action         |
|---------------------|----------------|
| Shorter than 5us    | Reset Rejected |
| Longer than 9us     | Reset          |
| Between 5us and 9us | Reset starts   |

- During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In –mode.) and then return to Default condition for Hardware Reset.
- Spike Rejection also applies during a valid reset pulse as shown below:





5. When Reset applied during Sleep In Mode.
6. When Reset applied during Sleep Out Mode.
7. It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

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## 9. Optical Characteristics

| Item               | Symbol | Condition.                        | Min                         | Typ.  | Max.  | Unit              | Remark            |            |
|--------------------|--------|-----------------------------------|-----------------------------|-------|-------|-------------------|-------------------|------------|
| Response time      | Tr+ Tf | $\theta=0^\circ$ 、 $\phi=0^\circ$ | -                           | 25    | 35    | .ms               | Note 3            |            |
| Contrast ratio     | CR     | At optimized viewing angle        | 640                         | 800   | -     | -                 | Note 4            |            |
| Color Chromaticity | White  | Wx                                | $\theta=0^\circ$ 、 $\phi=0$ | 0.251 | 0.301 | 0.351             |                   | Note 2,6,7 |
|                    |        | Wy                                |                             | 0.277 | 0.327 | 0.377             |                   |            |
| Viewing angle      | Hor.   | $\Theta R$                        | $CR \geq 10$                | 70    | 80    | -                 | Deg.              | Note 1     |
|                    |        | $\Theta L$                        |                             | 70    | 80    | -                 |                   |            |
|                    | Ver.   | $\Phi T$                          |                             | 70    | 80    | -                 |                   |            |
|                    |        | $\Phi B$                          |                             | 70    | 80    | -                 |                   |            |
| Brightness         | -      | -                                 | 400                         | 500   | -     | cd/m <sup>2</sup> | Center of display |            |
| Uniformity         | (U)    | -                                 | 75                          | -     | -     | %                 | Note 5            |            |

Ta=25±2°C

Note 1: Definition of viewing angle range

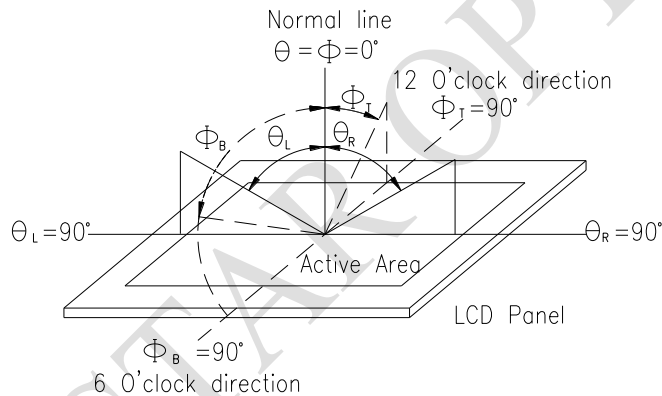


Fig. 9.1. Definition of viewing angle

Note 2: Test equipment setup:

After stabilizing and leaving the panel alone at a driven temperature for 10 minutes, the measurement should be executed. Measurement should be executed in a stable, windless, and dark room. Optical specifications are measured by Topcon BM-7or BM-5 luminance meter 1.0° field of view at a distance of 50cm and normal direction.

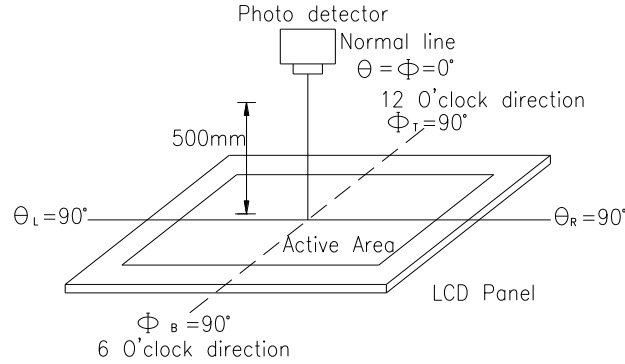
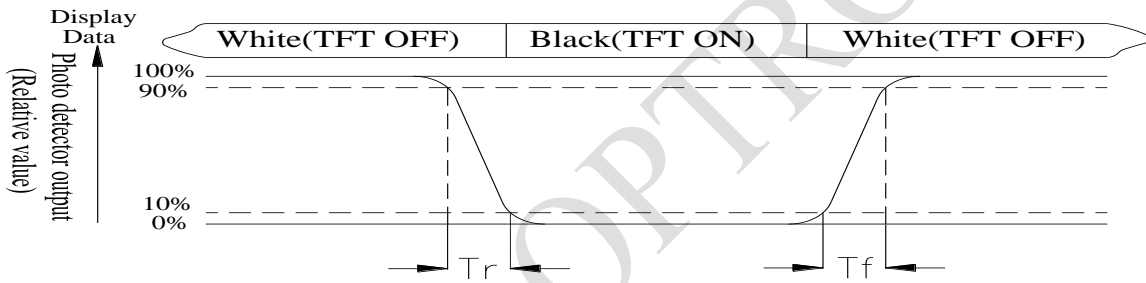


Fig. 9.2. Optical measurement system setup

**Note 3: Definition of Response time:**

The response time is defined as the LCD optical switching time interval between “White” state and “Black” state. Rise time,  $T_r$ , is the time between photo detector output intensity changed from 90% to 10%. And fall time,  $T_f$ , is the time between photo detector output intensity changed from 10% to 90%



**Note 4: Definition of contrast ratio:**

The contrast ratio is defined as the following expression.

$$\text{Contrast ratio (CR)} = \frac{\text{Luminance measured when LCD on the "White" state}}{\text{Luminance measured when LCD on the "Black" state}}$$

**Note 5: Definition of Luminance Uniformity**

Active area is divided into 9 measuring areas (reference the picture in below). Every measuring point is placed at the center of each measuring area.

$$\text{Luminance Uniformity (U)} = L_{\min}/L_{\max} \times 100\%$$

L = Active area length

W = Active area width

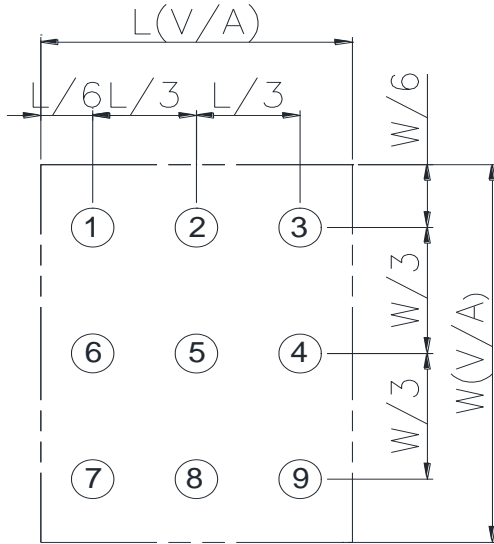


Fig 9.3. Definition of uniformity

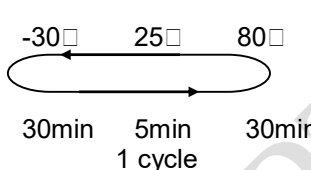
**Note 6: Definition of color chromaticity (CIE 1931)**

Color coordinates measured at the center point of LCD

Note 7: Measured at the center area of the panel when all the input terminals of LCD panel are electrically opened.

# 10. Reliability

Content of Reliability Test (Super Wide temperature, -30°C~80°C)

| Environmental Test                 |  |   |      |
|------------------------------------|--|---|------|
| Test Item                          | Content of Test  | Test Condition  | Note |
| High Temperature storage           | Endurance test applying the high storage temperature for a long time.  | 80°C<br>200hrs  | 2    |
| Low Temperature storage            | Endurance test applying the low storage temperature for a long time.   | -30°C<br>200hrs   | 1,2  |
| High Temperature Operation         | Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.   | 80°C<br>200hrs  | —    |
| Low Temperature Operation          | Endurance test applying the electric stress under low temperature for a long time.   | -30°C<br>200hrs   | 1    |
| High Temperature/ Humidity storage | The module should be allowed to stand at 60°C, 90%RH max   | 60°C, 90%RH<br>96hrs  | 1,2  |
| Thermal shock resistance           | The sample should be allowed stand the following 10 cycles of operation<br><br> | -30°C/80°C<br>10 cycles   | —    |
| Vibration test                     | Endurance test applying the vibration during transportation and using.   | Total fixed amplitude : 1.5mm<br>Vibration Frequency : 10~55Hz<br>One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes | 3    |
| Static electricity test            | Endurance test applying the electric stress to the terminal.   | VS=±600V(contact)<br>, ±800v(air),<br>RS=330Ω<br>CS=150pF<br>10 times   | —    |

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

## 11.Initial Code For Reference

External system porch setting:125>VBP $\geq$ 17, VFP $\geq$ 20

Two data lanes / maximum speed 550Mbps

Void ST7701S\_PanellInitialCode(void)

```

{
//-----Reset Sequence-----//
LCD_Nreset(1);
Delays (1); //Delay 1ms
LCD_Nreset(0);
Delays (1); //Delay 1ms
LCD_Nreset(1);
Delays (120); //Delay 120ms
WriteComm (0x11);
Delays (120); //Delay 120ms

//-----Initial setting-----//
WriteComm (0xFF);
WriteData (0x77);
WriteData (0x01);
WriteData (0x00);
WriteData (0x00);
WriteData (0x10);

WriteComm (0xC0);
WriteData (0x3B);
WriteData (0x00);

WriteComm (0xC1);
WriteData (0x0D);
WriteData (0x02);

WriteComm (0xC2);
WriteData (0x21);
WriteData (0x08);

WriteComm (0xCC);
WriteData (0x10);

WriteComm (0xB0);
WriteData (0x00);
WriteData (0x05);
WriteData (0x0F);
WriteData (0x0D);
WriteData (0x13);
WriteData (0x07);
WriteData (0x01);
WriteData (0x08);

```

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WriteData (0x09);  
WriteData (0x1E);  
WriteData (0x05);  
WriteData (0x12);  
WriteData (0x10);  
WriteData (0xA7);  
WriteData (0x2F);  
WriteData (0x18);

WriteComm (0xB1);  
WriteData (0x00);  
WriteData (0x0F);  
WriteData (0x17);  
WriteData (0x0C);  
WriteData (0x0D);  
WriteData (0x05);  
WriteData (0x01);  
WriteData (0x08);  
WriteData (0x08);  
WriteData (0x1E);  
WriteData (0x05);  
WriteData (0x13);  
WriteData (0x11);  
WriteData (0xA7);  
WriteData (0x2F);  
WriteData (0x18);

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WriteData (0x77);  
WriteData (0x01);  
WriteData (0x00);  
WriteData (0x00);  
WriteData (0x11);

WriteComm (0xB0);  
WriteData (0x4D);

WriteComm (0xB1);  
WriteData (0x4F);

WriteComm (0xB2);  
WriteData (0x07);

WriteComm (0xB3);  
WriteData (0x80);

WriteComm (0xB5);  
WriteData (0x47);

**WriteComm (0xB7);  
WriteData (0x85);**

**WriteComm (0xB8);  
WriteData (0x21);**

**WriteComm (0xB9);  
WriteData (0x10);**

**WriteComm (0xC1);  
WriteData (0x78);**

**WriteComm (0xC2);  
WriteData (0x78);**

**WriteComm (0xD0);  
WriteData (0x88);**

**Delays (100);**

**WriteComm (0xE0);  
WriteData (0x00);  
WriteData (0x00);  
WriteData (0x02);**

**WriteComm (0xE1);  
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WriteData (0x07);  
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WriteData (0x33);**

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WriteData (0x00);  
WriteData (0x00);  
WriteData (0x00);**



---

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WriteData (0x0A);  
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WriteData (0xA0);  
WriteData (0x0C);  
WriteData (0x2D);  
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WriteData (0x00);  
WriteData (0x00);  
WriteData (0x33);  
WriteData (0x33);

WriteComm (0xE7);  
WriteData (0x44);  
WriteData (0x44);

WriteComm (0xE8);  
WriteData (0x0D);  
WriteData (0x2D);  
WriteData (0xA0);

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WriteData (0xA0);  
WriteData (0x0F);  
WriteData (0x2D);  
WriteData (0xA0);  
WriteData (0xA0);  
WriteData (0x09);  
WriteData (0x2D);  
WriteData (0xA0);  
WriteData (0xA0);  
WriteData (0x0B);  
WriteData (0x2D);  
WriteData (0xA0);  
WriteData (0xA0);

WriteComm (0xEB);  
WriteData (0x02);  
WriteData (0x01);  
WriteData (0xE4);  
WriteData (0xE4);  
WriteData (0x44);  
WriteData (0x00);  
WriteData (0x40);

WriteComm (0xEC);  
WriteData (0x02);  
WriteData (0x01);

WriteComm (0xED);  
WriteData (0xAB);  
WriteData (0x89);  
WriteData (0x76);  
WriteData (0x54);  
WriteData (0x01);  
WriteData (0xFF);  
WriteData (0xFF);  
WriteData (0xFF);  
WriteData (0xFF);  
WriteData (0xFF);  
WriteData (0x10);  
WriteData (0x45);  
WriteData (0x67);  
WriteData (0x98);  
WriteData (0xBA);

WriteComm (0xFF);  
WriteData (0x77);  
WriteData (0x01);

**WriteData (0x00);**  
**WriteData (0x00);**  
**WriteData (0x00);**

**WriteComm (0x11);**

**WriteComm (0x36);**  
**WriteData (0x00);**

**WriteComm (0x29);**

**}**

RAYSTAR OPTRONICS

**LCM Sample Estimate Feedback Sheet**

**Module Number :** \_\_\_\_\_

**1 、 Panel Specification :**

|                            |                               |                                     |
|----------------------------|-------------------------------|-------------------------------------|
| 1. Panel Type :            | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 2. View Direction :        | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 3. Numbers of Dots :       | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 4. View Area :             | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 5. Active Area :           | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 6. Operating Temperature : | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 7. Storage Temperature :   | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 8. Others :                | _____                         |                                     |

**2 、 Mechanical Specification :**

|                             |                               |                                     |
|-----------------------------|-------------------------------|-------------------------------------|
| 1. PCB Size :               | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 2. Frame Size :             | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 3. Material of Frame :      | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 4. Connector Position :     | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 5. Fix Hole Position :      | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 6. Backlight Position :     | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 7. Thickness of PCB :       | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 8. Height of Frame to PCB : | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 9. Height of Module :       | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 10. Others :                | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |

**3 、 Relative Hole Size :**

|                             |                               |                                     |
|-----------------------------|-------------------------------|-------------------------------------|
| 1. Pitch of Connector :     | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 2. Hole size of Connector : | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 3. Mounting Hole size :     | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 4. Mounting Hole Type :     | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 5. Others :                 | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |

**4 、 Backlight Specification :**

|   |                               |                                     |
|---|-------------------------------|-------------------------------------|
| 1. B/L Type :                                     | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 2. B/L Color :                                    | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 3. B/L Driving Voltage (Reference for LED Type) : | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 4. B/L Driving Current :                          | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 5. Brightness of B/L :                            | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 6. B/L Solder Method :                            | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 7. Others :                                       | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |

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Module Number : \_\_\_\_\_

**5、Electronic Characteristics of Module :**

|                             |                               |                                     |
|-----------------------------|-------------------------------|-------------------------------------|
| 1.Input Voltage :           | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 2.Supply Current :          | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 3.Driving Voltage for LCD : | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 4.Contrast for LCD :        | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 5.B/L Driving Method :      | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 6.Negative Voltage Output : | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 7.Interface Function :      | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 8.LCD Uniformity :          | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 9.ESD test :                | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |
| 10.Others :                 | <input type="checkbox"/> Pass | <input type="checkbox"/> NG , _____ |

**6、Summary :**

Sales signature : \_\_\_\_\_

Customer Signature : \_\_\_\_\_

Date : / /